Semi – Automatic Solder Paste Printer – ET 1200 SP

The **ET 1200 SP** is a high-performance semi-automatic solder paste printer designed for precise and stable PCB printing. It features a PLC control system with a user-friendly touch screen, ensuring smooth operation and reliable performance. The machine automatically adjusts printing parameters based on the type of solder paste or glue used, improving consistency and efficiency. Its flexible arming base and 45° rotating squeegee holder make maintenance and setup convenient for various PCB sizes.

Specifications:

Model	ET 1200 SP
Power Requirement	220V AC, 50Hz, 1 Phase
Power Consumption	100W
PCB Thickness Range	0.2-3.0 mm
Fine Adjustment of Platform	± 0.05 mm
Respectable Precision	± 0.02 mm
Air Supply	4-6 Kg/cm sq
Printing Plat form	350 X 1200 mm
PCB Dimension	300 X 1200 mm
PCB Positioning Method	Positioning Pin
Printing Method	Stencil Movement
Dimension	L-1350, W-870, H-1650 mm
Weight	280Kg

Features:

- **PLC Control System with Touchscreen** – Ensures stable, user-friendly, and programmable operation.
- **Rigid Structure with Linear Rails** – Provides high stability and precision during printing.
- **Automatic Parameter Adjustment** – Adapts settings for different solder pastes and glue types.
- **Adjustable Arming Base** – Supports PCBs of various sizes with flexible right/left movement.
- **45° Rotatable Squeegee Holder** – Enables easy cleaning and stencil replacement for quick maintenance.

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